

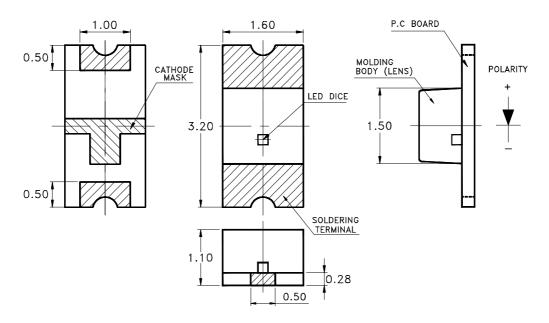
Features

- 3.2mm*1.6mm SMT LED, Super thin (1.1H mm)
- Low Power Consumption
- Wide Viewing Angle
- Various Colors
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow and wave solder process.
- Meet ROHS Green Products
- Package: 3000pcs/Reel

Applications

· Backlight and Indicator

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.2 mm (.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for reference, not as a basis for the actual structure.

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FSL-3216110TB-RDBNC3

Selection Guide

Part No	Lens Type	Dice	Emitted Color
FSL-3216110TB-RDBNC3	Water Clear	InGaN	Blue

Electrical / Optical Characteristics At Ta=25℃

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Iv	Luminous Intensity	45	112	280	mcd	IF=20mA
201/2	Viewing Angle		130		deg	IF=20mA
入 Peak	Peak Emission Wavelength		468		nm	IF=20mA
入d	Dominant Wavelength	460	470	475	nm	IF=20mA
$\triangle \lambda$	Spectral Line Half-Width		25		nm	IF=20mA
VF	Forward Voltage		3.0		V	IF=20mA
IR	Reverse Current			10	μА	VR 5V

Note:

Absolute Maximum Ratings At Ta=25℃

Parameter	Blue	Unit	
Power Dissipation	76	mW	
Peak Forward Current[1]	100	mA	
Continuous Forward Current	20	mA	
Derating Linear From 25℃	0.25	mA/℃	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold (HBM)	150	V	
Operating Temperature Range	-20°C to + 80°C		
Storage Temperature Range	-30°C to + 100°C		
Soldering Condition	260°C For 5 Seconds		

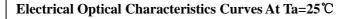
Note:

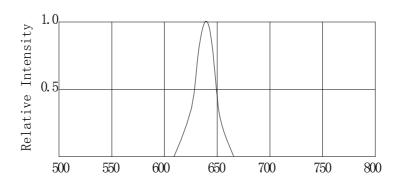
1. 1/10DutyCycle, 0.1msPulseWidth

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 $^{1. \}theta 1/2$ is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value







Wavelength λ (nm)

Fig. 1 Relative Intensity vs. Wavelength

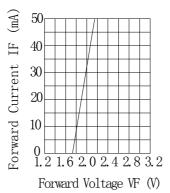
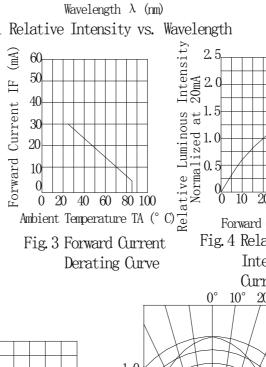
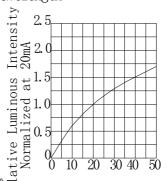
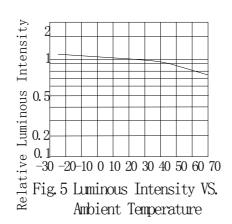


Fig. 2 Forward Current VS. Forward Voltage





Forward Current (mA) Fig. 4 Relative Luminous Intensity VS. Forward Current



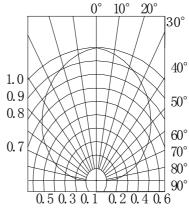


Fig. 6 Spatial Distribution

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Bin Range Of Luminous Intensity

Symbol	Bin Code	Min.	Max.	Unit	Condition
	P	45	72	med	IF=20mA
Try	Q	72	112		
Iv	R	112	180		
	S	180	288		

Bin Range Of Forward Voltage

Symbol	Bin Code	Min.	Max.	Unit	Condition
VF	V0	2.6	2.8	3.0 3.2 3.4 3.6	IF=20mA
	V1	2.8	3.0		
	V2	3.0	3.2		
	V3	3.2	3.4		
	V4	3.4	3.6		
	V5	3.6	3.8		

Bin Range Of Dominate Wavelength

Symbol	Bin Code	Min.	Max.	Unit	Condition
	В	460	465	nm	IF=20mA
入 d	С	465	470		
	D	470	475		

Notes:

1. Tolerance of Luminous Intensity +/-20%

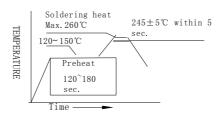
2. Tolerance of Forward Voltage +/-0.2V

3. Tolerance of the Dominate Wavelength +/- 2nm

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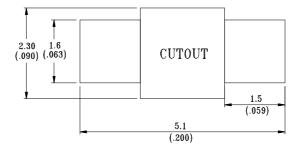
SMT Reflow Soldering Instructions



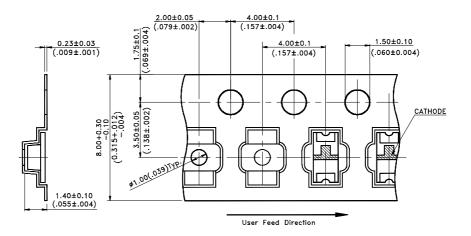
Notes:

- Sells gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- Do not stress LED when soldering, and do not warp the circuit board after soldering
- While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

Recommended Soldering Pad Dimensions



Package Specifications (Units: mm (inches))



Notes:

- The LEDs should be used within a year.
- The LEDs should be kept in 5~30°C and 60% RH for less.
- The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

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Reliability Test Items Conditions

Classification	Test Item	Test Conditions	Test hours	Result
	Opertion Life	Connect with a power if=20mA Ta=Under room temperature	1000Hrs	0/20
	Hige Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
Endurance Test	Hige Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
	Temperature Cycling	-45°C∼+105°C 15min 5min 15min	300 Cycles	0/20
Environmental	Thermal Shock	-35°C~±5°C~+85°C~±5°C 5min 10sec 5min	300 Cycles	0/20
Test	Solder Resistance	Preheating: 120°C-150°C, within 2 minutes. Operation heating: 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V _F (V)	IF=20mA	Over U×1.2
Rvevrse current	$I_R(\mu A)$	V _R =5V	Over U×2
Luminous intensity	Iv(mcd)	IF=20mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.

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